

MOSFET - N-Channel, SUPERFET® II

600 V, 10.2 A, 380 mΩ

FCP380N60, FCPF380N60

Description

SUPERFET II MOSFET is **onsemi**'s brand-new high voltage super-junction (SJ) MOSFET family that is utilizing charge balance technology for outstanding low on-resistance and lower gate charge performance. This technology is tailored to minimize conduction loss, provide superior switching performance, dv/dt rate and higher avalanche energy. Consequently, SUPERFET II MOSFET is very suitable for the switching power applications such as PFC, server/telecom power, FPD TV power, ATX power and industrial power applications.

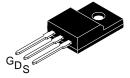
Features

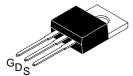
- 650 V @ $T_J = 150$ °C
- Typ. $R_{DS(on)} = 330 \text{ m}\Omega$
- Ultra Low Gate Charge (Typ. Q_g = 30 nC)
- Low Effective Output Capacitance (Typ. C_{oss(eff.)} = 95 pF)
- 100% Avalanche Tested
- RoHS Compliant

Applications

- LCD / LED / PDP TV Lighting
- Solar Inverter
- AC-DC Power Supply

V _{DSS}	R _{DS(on)} MAX	I _D MAX
600 V	380 mΩ @ 10 V	10.2 A





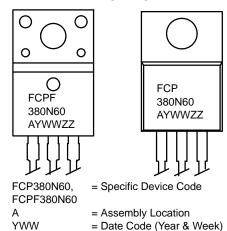
TO-220 Fullpack, 3-Lead / TO-220F-3SG CASE 221AT

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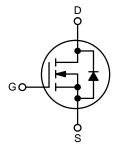
TO-220-3LD CASE 340AT

MARKING DIAGRAM



N-CHANNEL MOSFET

= Assembly Lot



ORDERING INFORMATION

Part Number	Package	Shipping	
FCP380N60	TO-220	800 Units / Tube	
FCPF380N60	TO-220F	1000 Units / Tube	

ABSOLUTE MAXIMUM RATINGS ($T_C = 25^{\circ}C$, unless otherwise noted)

Symbol	Parameter		FCP380N60	FCPF380N60	Unit
V_{DSS}	Drain to Source Voltage		600		V
V_{GSS}	Gate to Source Voltage	- DC	±20		V
		– AC (f > 1 Hz)	±30		
I _D	Drain Current	– Continuous (T _C = 25°C)	10.2	10.2*	Α
		- Continuous (T _C = 100°C)	6.4	6.4*	
I _{DM}	Drain Current	- Pulsed (Note 1)	30.6	30.6*	Α
E _{AS}	Single Pulsed Avalanche Energy (Note 2)		211.6		mJ
I _{AR}	Avalanche Current (Note 1)		2.3		Α
E _{AR}	Repetitive Avalanche Energy (Note 1)		1.06		mJ
dv/dt	MOSFET dv/dt		100		V/ns
	Peak Diode Recovery dv/dt (Note 3) 20		20		
P_{D}	Power Dissipation	(T _C = 25°C)	106	31	W
		– Derate Above 25°C	0.85	0.25	W/°C
T _J , T _{STG}	Operating and Storage Temperature Range		-55 to +150		°C
TL	Maximum Lead Temperature for Soldering, 1/8" from Case for 5 Seconds		3	00	°C

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected. *Drain current limited by maximum junction temperature.

THERMAL CHARACTERISTICS

Symbol	Parameter	FCP380N60	FCPF380N60	Unit
$R_{\theta JC}$	Thermal Resistance, Junction to Case, Max.	1.18	4	°C/W
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient, Max.	62.5	62.5	

^{1.} Repetitive rating: pulse–width limited by maximum junction temperature. 2. $I_{AS} = 2.3 \text{ A}$, $V_{DD} = 50 \text{ V}$, $R_G = 25 \Omega$, starting $T_J = 25^{\circ}\text{C}$. 3. $I_{SD} \le 5.1 \text{ A}$, di/dt $\le 200 \text{ A/}\mu\text{s}$, $V_{DD} \le \text{BV}_{DSS}$, starting $T_J = 25^{\circ}\text{C}$.

ELECTRICAL CHARACTERISTICS ($T_C = 25$ °C unless otherwise noted)

Symbol	Parameter	Test Conditions	Min	Тур	Max	Unit
OFF CHAR	ACTERISTICS	•		•		
BV _{DSS}	Drain to Source Breakdown Voltage	V _{GS} = 0 V, I _D = 10 mA, T _J = 25°C	600	_	_	V
		V _{GS} = 0 V, I _D = 10 mA, T _J = 150°C	-	650	-	V
$\Delta BV_{DSS} / \Delta T_{J}$	Breakdown Voltage Temperature Coefficient	I _D = 10 mA, Referenced to 25°C	-	0.6	-	V/°C
BV _{DS}	Drain to Source Avalanche Breakdown Voltage	V _{GS} = 0 V, I _D = 10 A	-	700	-	V
I _{DSS}	Zero Gate Voltage Drain Current	V _{DS} = 480 V, V _{GS} = 0 V	-	-	1	μΑ
		V _{DS} = 480 V, T _C = 125°C	_	_	10	
I _{GSS}	Gate to Body Leakage Current	V _{GS} = ±20 V, V _{DS} = 0 V	_	_	±100	nA
	CTERISTICS				1	
V _{GS(th)}	Gate Threshold Voltage	$V_{GS} = V_{DS}, I_{D} = 250 \mu A$	2.5	_	3.5	V
R _{DS(on)}	Static Drain to Source On Resistance	V _{GS} = 10 V, I _D = 5 A	_	0.33	0.38	Ω
9FS	Forward Transconductance	V _{DS} = 20 V, I _D = 5 A	_	11	_	S
DYNAMIC (CHARACTERISTICS				1	1
C _{iss}	Input Capacitance	V _{DS} = 25 V, V _{GS} = 0 V, f = 1 MHz	_	1250	1665	pF
C _{oss}	Output Capacitance	1	_	905	1205	pF
C _{rss}	Reverse Transfer Capacitance	1	_	45	60	pF
C _{oss}	Output Capacitance	V _{DS} = 380 V, V _{GS} = 0 V, f = 1 MHz	_	23	_	pF
C _{oss(eff.)}	Effective Output Capacitance	V _{DS} = 0 V to 480 V, V _{GS} = 0 V	_	95	_	pF
Q _{g(tot)}	Total Gate Charge at 10 V	V _{DS} = 380 V, I _D = 5 A, V _{GS} = 10 V	_	30	40	nC
Q _{gs}	Gate to Source Gate Charge	(Note 4)	_	5	-	nC
Q _{gd}	Gate to Drain "Miller" Charge	1	_	10	_	nC
ESR	Equivalent Series Resistance	f = 1 MHz	_	1	_	Ω
SWITCHING	CHARACTERISTICS					J.
t _{d(on)}	Turn-On Delay Time	V _{DD} = 380 V, I _D = 5 A, V _{GS} = 10 V,	_	14	38	ns
t _r	Turn-On Rise Time	$R_G = 4.7 \Omega \text{ (Note 4)}$	_	7	24	ns
t _{d(off)}	Turn-Off Delay Time	1	_	45	100	ns
t _f	Turn-Off Fall Time	1	_	6	22	ns
	JRCE DIODE CHARACTERISTICS		•			
I _S	Maximum Continuous Drain to Source Diode Forward Current		_	_	10.2	Α
I _{SM}	Maximum Pulsed Drain to Source Diode	Forward Current	_	_	30.6	Α
V _{SD}	Drain to Source Diode Forward Voltage	V _{GS} = 0 V, I _{SD} = 5 A	-	_	1.2	V
t _{rr}	Reverse Recovery Time	$V_{GS} = 0 \text{ V}, I_{SD} = 5 \text{ A}, dI_F/dt = 100 \text{ A/}\mu\text{s}$	-	240	_	ns
Q _{rr}	Reverse Recovery Charge	1	-	2.7		μС

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

4. Essentially independent of operating temperature typical characteristics.

TYPICAL PERFORMANCE CHARACTERISTICS

ID, Drain Current (A)

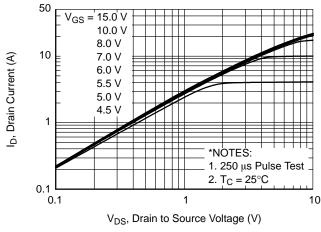


Figure 1. On-Region Characteristics

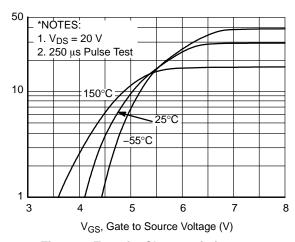


Figure 2. Transfer Characteristics

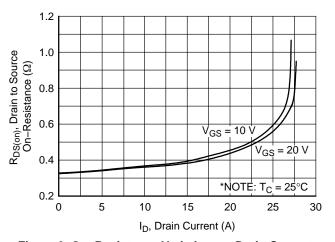


Figure 3. On-Resistance Variation vs. Drain Current and Gate Voltage

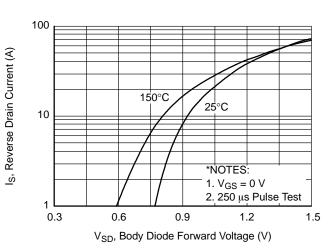


Figure 4. Body Diode Forward Voltage Variation vs.
Source Current and Temperature

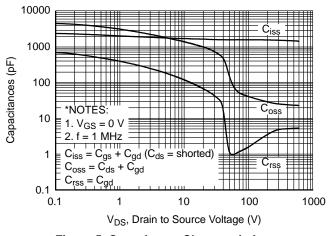


Figure 5. Capacitance Characteristics

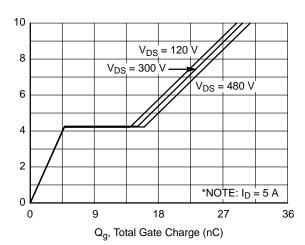


Figure 6. Gate Charge Characteristics

V_{GS}, Gate to Source Voltage (V)

TYPICAL PERFORMANCE CHARACTERISTICS (CONTINUED)

ID, Drain Current (A)

Eoss (µJ)

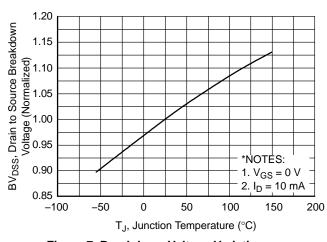


Figure 7. Breakdown Voltage Variation vs. Temperature

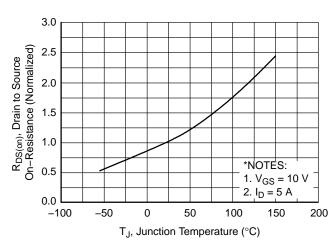


Figure 8. On–Resistance Variation vs. Temperature

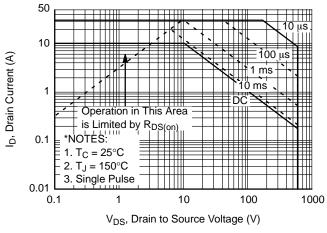


Figure 9. Maximum Safe Operating Area for FCP380N60

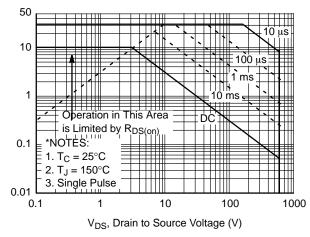


Figure 10. Maximum Safe Operating Area for FCPF380N60

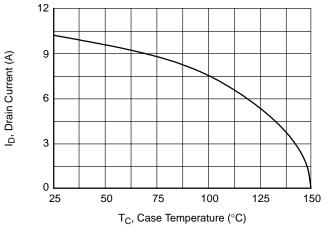


Figure 11. Maximum Drain Current vs.

Case Temperature

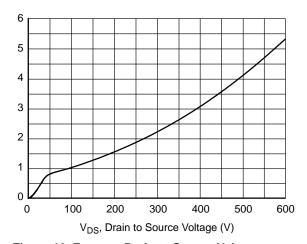


Figure 12. E_{OSS} vs. Drain to Source Voltage

TYPICAL PERFORMANCE CHARACTERISTICS (CONTINUED)

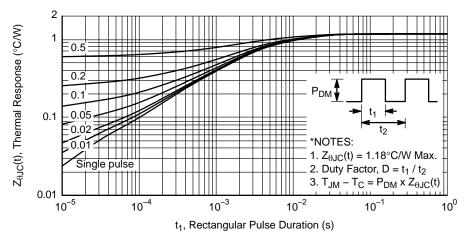


Figure 13. Transient Thermal Response Curve for FCP380N60

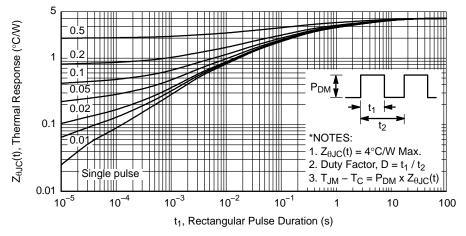


Figure 14. Transient Thermal Response Curve for FCPF380N60

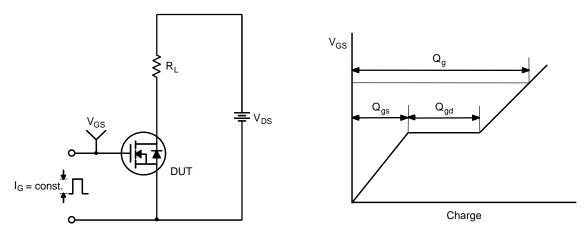


Figure 15. Gate Charge Test Circuit & Waveform

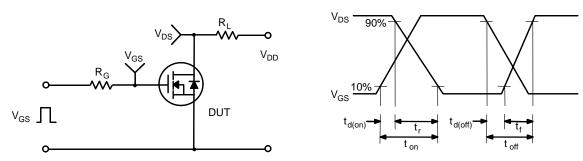


Figure 16. Resistive Switching Test Circuit & Waveforms

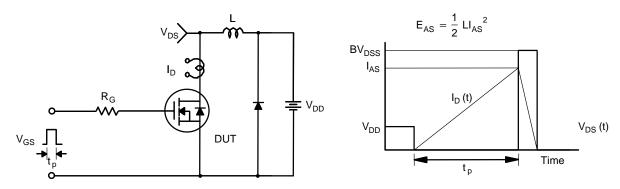
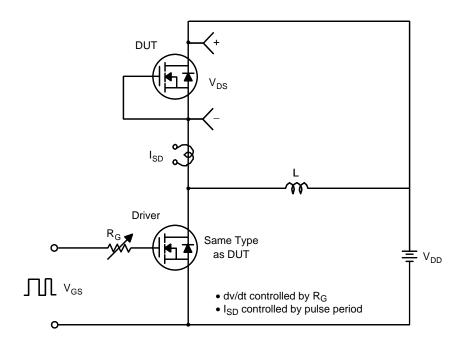


Figure 17. Unclamped Inductive Switching Test Circuit & Waveforms



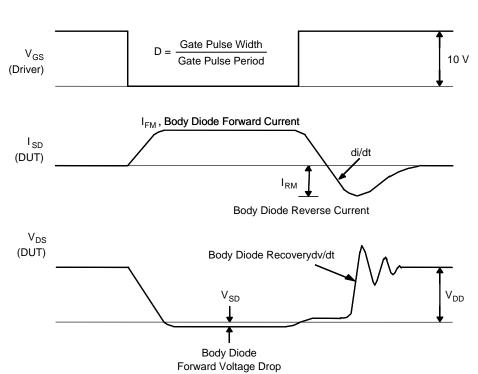
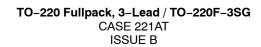


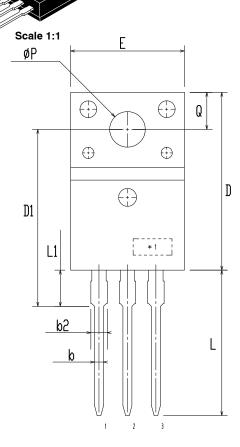
Figure 18. Peak Diode Recovery dv/dt Test Circuit & Waveforms

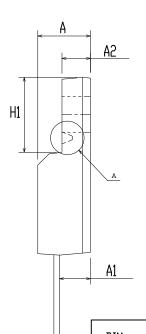
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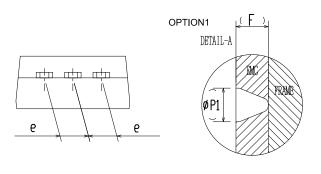




DATE 19 JAN 2021







DIM	HILLIHITENS			
ויונע	MIN	NDM	MAX	
Α	4.50	4.70	4.90	
A1	2.56	2.76	2.96	
A2	2.34	2.54	2.74	
b	0.70	0.80	0.90	
b2	~	2	1.47	
С	0.45	0.50	0.60	
D	15.67	15.87	16.07	
D1	15.60	15.80	16.00	
E	9.96	10.16	10.36	
е	2.34	2.54	2.74	
F	~	0.84	~	
H1	6.48	6.68	6.88	
L	12.78	12.98	13.18	
L1	3.03	3.23	3.43	
øΡ	2.98	3.18	3.38	
ø P1	~	1.00	~	
Q	3.20	3.30	3.40	
_				

MILL IMITERS

NOTES:

- A. DIMENSION AND TOLERANCE AS ASME Y14.5-2009
- B. DIMENSIONS ARE EXCLUSIVE OF BURRS, MOLD FLASH AND TIE BAR PROTRUCSIONS.

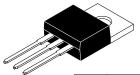
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C. OPTION 1 - WITH SUPPORT PIN HOLE OPTION 2 - NO SUPPORT PIN HOLE

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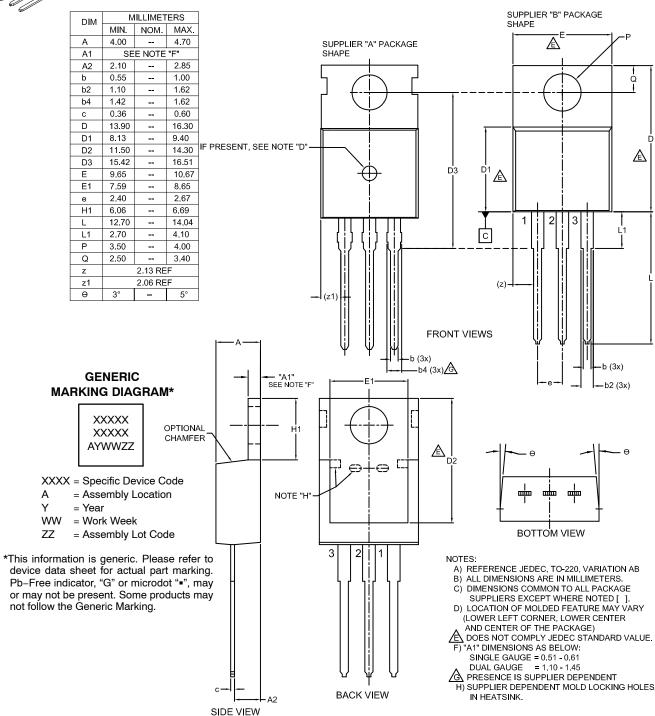
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TO-220-3LD CASE 340AT ISSUE B

DATE 08 AUG 2022



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